

To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Phase-out/Discontinued

NX6506 Series

1 550 nm InGaAsP MQW-DFB LASER DIODE FOR 622 Mb/s, 1.25 Gb/s

DESCRIPTION

The NX6506 Series is a 1 550 nm Multiple Quantum Well (MQW) structured Distributed Feed-Back (DFB) laser diode with InGaAs monitor PIN-PD.

APPLICATIONS

- STM-1, STM-4, ITU-T recommendations
- FTTH PON (Fiber To The Home Passive Optical Network)
- 1.25 Gb/s: Gigabit Ethernet

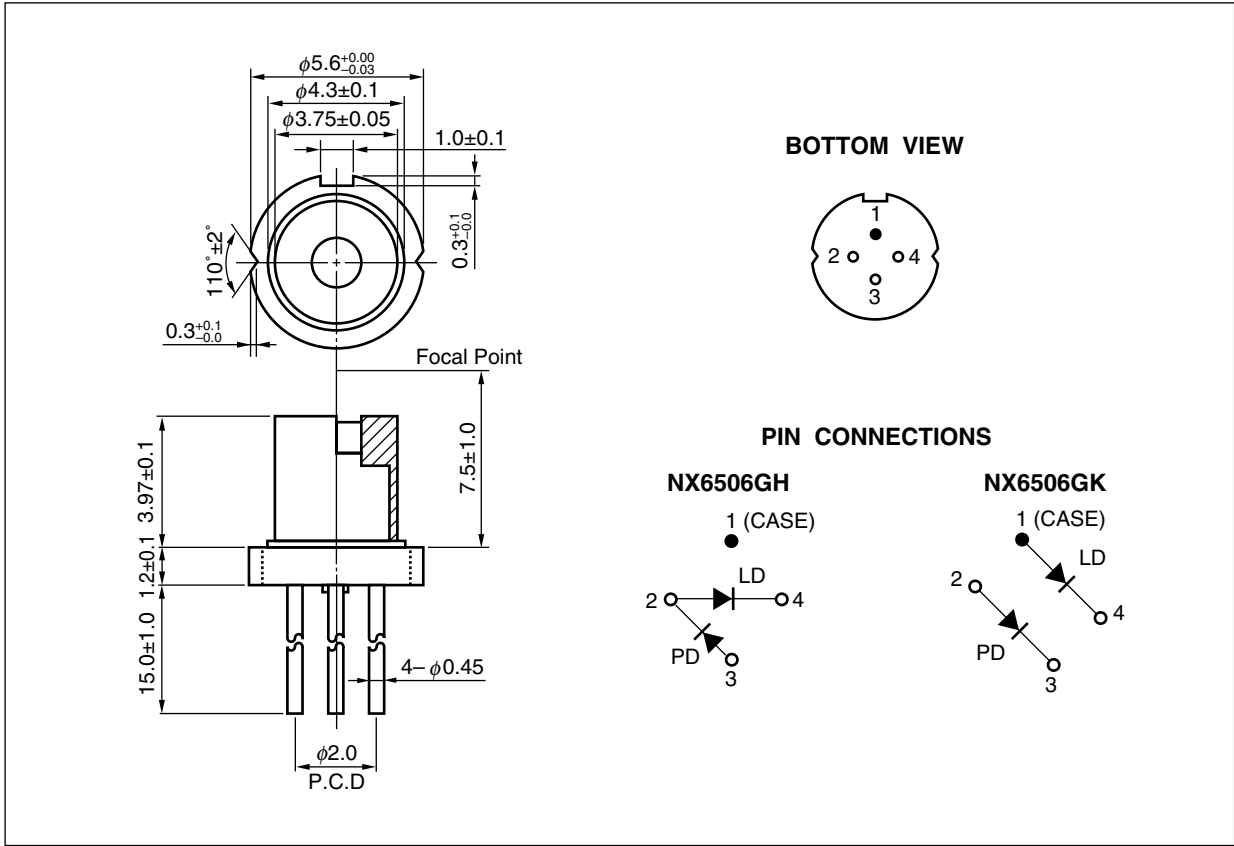
FEATURES

- | | |
|------------------------------------|---|
| • Optical output power | $P_o = 5.0 \text{ mW}$ |
| • Low threshold current | $I_{th} = 10 \text{ mA}$ |
| • Differential efficiency | $\eta_d = 0.25 \text{ W/A}$ |
| • Side mode suppression ratio | SMSR = 40 dB |
| • Wide operating temperature range | $T_c = -20 \text{ to } +85^\circ\text{C}$ |
| • InGaAs monitor PIN-PD | |
| • CAN package | $\phi 5.6 \text{ mm}$ |
| • Focal point | 7.5 mm |

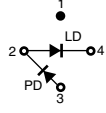
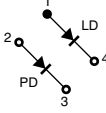


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Not all devices/types available in every country. Please check with local NEC Compound Semiconductor Devices representative for availability and additional information.

PACKAGE DIMENSIONS (UNIT: mm)



ORDERING INFORMATION

Part Number	Package	Pin Connections
NX6506GH	4-pin CAN with aspherical lens cap	
NX6506GK		

Remark The hermetic test will be performed as AQL 1.0%.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Ratings	Unit
Optical Output Power	P _o	10	mW
Forward Current of LD	I _F	150	mA
Reverse Voltage of LD	V _R	2.0	V
Forward Current of PD	I _F	2.0	mA
Reverse Voltage of PD	V _R	15	V
Operating Case Temperature	T _C	-20 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
Lead Soldering Temperature	T _{slid}	350 (3 sec.)	°C
Relative Humidity (noncondensing)	RH	85	%

ELECTRO-OPTICAL CHARACTERISTICS (T_C = -20 to +85°C, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Optical Output Power	P _o	CW		5.0		mW
Operating Voltage	V _{op}	P _o = 5.0 mW		1.1	1.6	V
Threshold Current	I _{th}	T _C = 25°C		10	20	mA
					50	
Differential Efficiency	η _d	P _o = 5.0 mW, T _C = 25°C	0.18	0.25		W/A
		P _o = 5.0 mW	0.10			
Temperature Dependence of Differential Efficiency	Δη _d	$\Delta\eta_d = 10 \log \frac{\eta_d (@ 85^\circ\text{C})}{\eta_d (@ 25^\circ\text{C})}$	-3.0	-1.6		dB
Peak Emission Wavelength	λ _p	CW, P _o = 5.0 mW	1 530		1 570	nm
Side Mode Suppression Ratio	SMSR	P _o = 5.0 mW	30	40		dB
Rise Time	t _r	I _b = I _{th} , 20-80%			100	ps
Fall Time	t _f	I _b = I _{th} , 80-20%			150	ps
Monitor Current	I _m	V _R = 1.5 V, P _o = 5.0 mW	200	600	2 000	μA
Monitor Dark Current	I _D	V _R = 1.5 V, T _C = 25°C		0.1	10	nA
		V _R = 1.5 V		10	100	

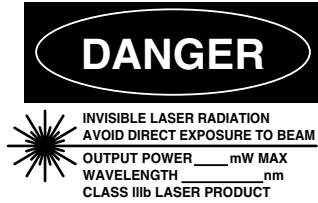
REFERENCE

Document Name	Document No.
OPTICAL SEMICONDUCTOR DEVICES FOR FIBEROPTIC COMMUNICATIONS SELECTION GUIDE	PL10161E
Opto-Electronics Devices Pamphlet	PX10160E

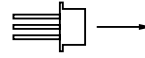
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M8E 00.4-0110

SAFETY INFORMATION ON THIS PRODUCT



SEMICONDUCTOR LASER



AVOID EXPOSURE-Invisible
Laser Radiation is emitted from
this aperture

<p>Warning Laser Beam</p>	<p>A laser beam is emitted from this diode during operation. The laser beam, visible or invisible, directly or indirectly, may cause injury to the eye or loss of eyesight.</p> <ul style="list-style-type: none"> • Do not look directly into the laser beam. • Avoid exposure to the laser beam, any reflected or collimated beam.
<p>Caution GaAs Products</p>	<p>This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none"> • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. <ol style="list-style-type: none"> 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth.

► For further information, please contact

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